# **Dual N-Channel 20-V (D-S) MOSFET**

## **Key Features:**

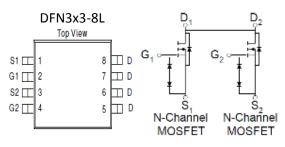
- Low r<sub>DS(on)</sub> trench technology
- · Low thermal impedance
- Fast switching speed

<b>Typical</b>	An	plica	ation	is:
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- Power Routing
- · Li Ion Battery Packs
- · Level Shifting and Driver Circuits

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	$r_{DS(on)}(m\Omega)$	I <sub>D</sub> (A)		
20	$10 @ V_{GS} = 4.5V$	13		
	14 @ V <sub>GS</sub> = 2.5V	11		







ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C UNLESS OTHERWISE NOTED)						
Parameter		Symbol	Limit	Units		
Drain-Source Voltage			20	V		
Gate-Source Voltage	Gate-Source Voltage					
Continuous Brain Commental	T <sub>A</sub> =25°C	ı	13			
Continuous Drain Current a	T <sub>A</sub> =70°C	i <sub>D</sub>	10	Α		
Pulsed Drain Current <sup>b</sup>	I <sub>DM</sub>	50				
Continuous Source Current (Diode Conduction) a		Is	7	Α		
Device Discipation 8	T <sub>A</sub> =25°C	P <sub>D</sub>	2.5	W		
Power Dissipation <sup>a</sup>	T <sub>A</sub> =70°C	L.D	1.5	VV		
Operating Junction and Storage Temperature Range	$T_J$ , $T_{stg}$	-55 to 150	°C			

THERMAL RESISTANCE RATINGS							
Parameter			Maximum	Units			
Maximum Junction-to-Ambient <sup>a</sup>	t <= 10 sec	$R_{\theta JA}$	83	°C/W			
Maximum Junction-to-Ambient	Steady State	IN <sub>θ</sub> JΑ	120	C/VV			

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#### Notes

- a. Surface Mounted on 1" x 1" FR4 Board.
- b. Pulse width limited by maximum junction temperature

### **Electrical Characteristics**

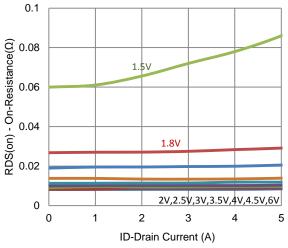
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Static						
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = 250 \text{ uA}$	0.4			V
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			±10	uA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 16 \text{ V}, V_{GS} = 0 \text{ V}$	1 10		uA	
Zero Gate Voltage Brain Gurrent	DSS	$V_{DS} = 16 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55^{\circ}\text{C}$			u.A	
On-State Drain Current <sup>a</sup>	$I_{D(on)}$	$V_{DS} = 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	20			Α
Drain-Source On-Resistance <sup>a</sup>	r	$V_{GS} = 4.5 \text{ V}, I_{D} = 2 \text{ A}$			10 mΩ	
Drain-Source On-Resistance	r <sub>DS(on)</sub>	$V_{GS} = 2.5 \text{ V}, I_D = 1.6 \text{ A}$			14	11122
Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	$V_{DS} = 15 \text{ V}, I_{D} = 2 \text{ A}$		3		S
Diode Forward Voltage <sup>a</sup>	$V_{SD}$	$I_S = 3.5 \text{ A}, V_{GS} = 0 \text{ V}$		0.8		V
		Dynamic <sup>b</sup>				
Total Gate Charge	$Q_g$	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V},$		15		
Gate-Source Charge	$Q_gs$	$I_D = 2 A$		1.9		nC
Gate-Drain Charge	$Q_gd$	10 – 2 /\		3.7		
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DS} = 10 \text{ V}, R_{L} = 5 \Omega,$		178		
Rise Time	t <sub>r</sub>	$I_{DS} = 10 \text{ V}, \text{ NL} = 3.52,$ $I_{D} = 2 \text{ A},$		332		ne
Turn-Off Delay Time	$t_{d(off)}$	$V_{GEN} = 4.5 \text{ V}, R_{GEN} = 6 \Omega$		1939		ns
Fall Time	t <sub>f</sub>	V GEN - 4.5 V, T GEN 0 12		902		
Input Capacitance	$C_{iss}$			1225		
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ Mhz}$		151		pF
Reverse Transfer Capacitance	$C_{rss}$			123		

#### Notes

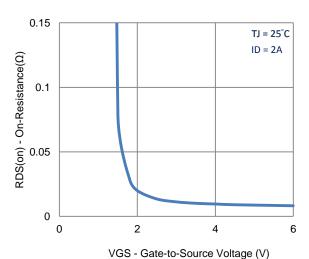
- a. Pulse test: PW <= 300us duty cycle <= 2%.
- b. Guaranteed by design, not subject to production testing.

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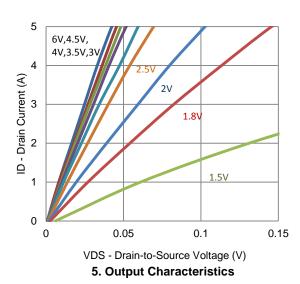
## **Typical Electrical Characteristics**

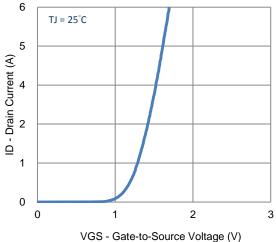


#### 1. On-Resistance vs. Drain Current

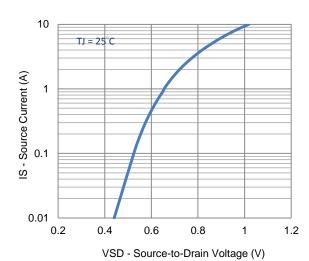


3. On-Resistance vs. Gate-to-Source Voltage

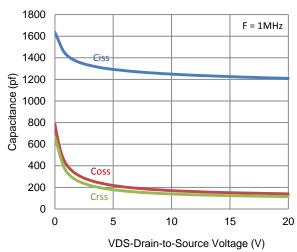




2. Transfer Characteristics

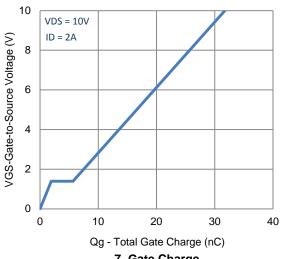


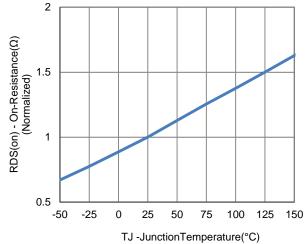
4. Drain-to-Source Forward Voltage



6. Capacitance

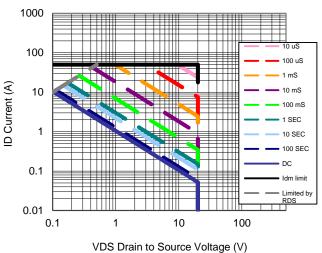
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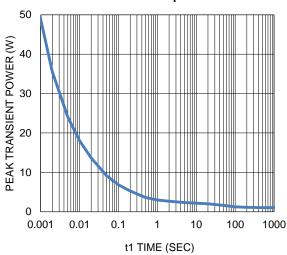




7. Gate Charge

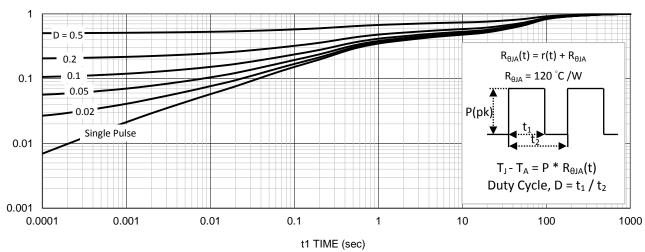






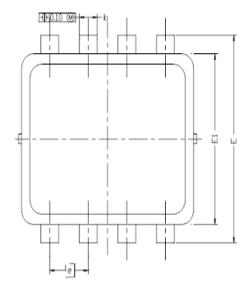
9. Safe Operating Area

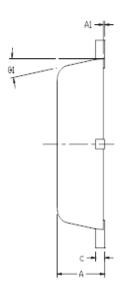
10. Single Pulse Maximum Power Dissipation

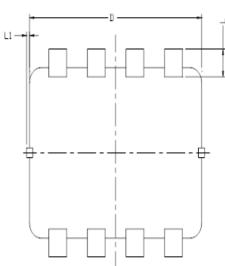


11. Normalized Thermal Transient Junction to Ambient

# Package Information







DIM.	MILLIMETERS			INCHES			
DIM.	MIN	NDM	MAX	MIN	NDM	MAX	
Α	0.700	0.80	0.900	0.0276	0.0315	0.0354	
A1	0.00		0.05	0.000		0.002	
b	0.24	0.30	0.35	0.009	0.012	0.014	
	0.08	0.152	0.25	0.003	0,006	0.010	
D	2	2.90 BSC 0.114 BSC				C	
E	2.80 BSC 0.110 BSC			C			
E1	2.30 BSC			0.091 BSC			
9	0.65 BSC			0.026 BSC			
L	0.20	0.375	0.450	0.008	0.0148	0.0177	
L1	0		0.100	0		0.004	
91	0	10	12	0	10	12	